



Declaration for U.S. Patent Application

As a below name	d inventor, I hereby declare that:				
My residence, po	st office address and citizenship	are as stated below nex	kt to my name.		
names are listed to (Insert Title)	original, first and sole inventor (below) of the subject matter which VIBRATION ABSORBING H of which is attached hereto unless	h is claimed and for w OSE	sted below) or an original, first and hich a patent is sought on the inver ked	joint inventor (if plural ntion entitled	
	was filed on Number	s filed on as United smber and was a		States Application Number or PCT International Application amended on (if applicable)	
	t I have reviewed and understand amendment referred to above.	the contents of the ab	ove-identified specification, includ	ing the claim(s), as	
I acknowledge the 1.56.	e duty to disclose information wh	uch is material to pate	ntability as defined in Title 37, Cod	le of Federal Regulations,	
inventor's certific	reign priority benefits under Title ate listed below and have also ide that of the application for which	entified below any fore	le, § 119 (a) - (d) of any foreign appeign application for patent or invent	plication(s) for patent or tor's certificate having a	
				Priority Claimed	
(List prior foreign	IP2001_024601	<u>Japan</u>	31/January/2001	X Yes _ No	
applications.	(Number)	(Country)	(Day/Month/Year Filed)	Yes No	
See note A on	(Number)	(Country)	(Day/Month/Year Filed)	100 110	
back of this				Yes No	
page)	(Number)	(Country)	(Day/Month/Year Filed)	Yes No	
	(Number)	(Country)	(Day/Month/Year Filed)	165 140	
(See note B on ba	ck of this page)	See attacl	ned list for additional prior foreign	applications	
subject matter of the first paragrap patentability as de	each of the claims of this applicate h of Title 35, United States Co	tion is not disclosed in ode, § 112, I acknow ral Regulations, § 1.56	ny United States application(s) liste the prior United States application ledge the duty to disclose inform 6 which became available between cation.	in the manner provided by	

(List Prior U.S. Applications)

(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)
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I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Inventor's signature _		Date	
Residence		Citizenship	
	entor (given name, family name)		
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Rev. 03/97		_	



3

NOTES

- A. Please list all foreign applications relating to the invention and check block "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate city and state, for residence outside the U.S., indicate city and country. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.